

# SMD High Frequency Power Inductor

## Designed for VRM 9.x, 10.x, & 11.x Applications

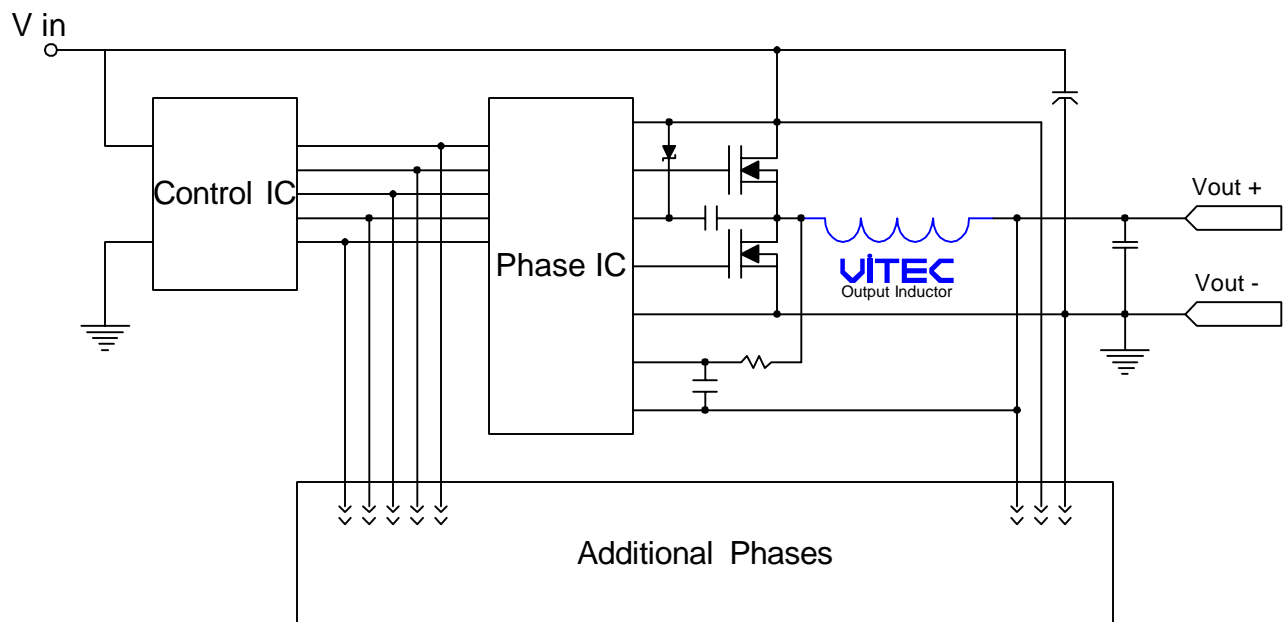
### FEATURES

- Recommended for use with all major Voltage Regulator ICs
- High Current handling capability in the smallest footprint & profile
- Up to 2MHz operating frequency
- Extended operating temperature range: -40°C to 125°C
- Robust SMD package capable of handling the most aggressive SMT assembly process
- RoHS compliant version available



### APPLICATIONS

- VRM 9.0, 10.x, and 11.x based designs
- Multi-Phase Voltage regulator designs
- Server, Desktop, PDA, Graphics cards, Notebook computers, DDR, telecom switches and routers
- DC-DC converters, Battery powered devices, high current power supplies
- High Current NPUs in networking equipment
- Point-of-load Modules

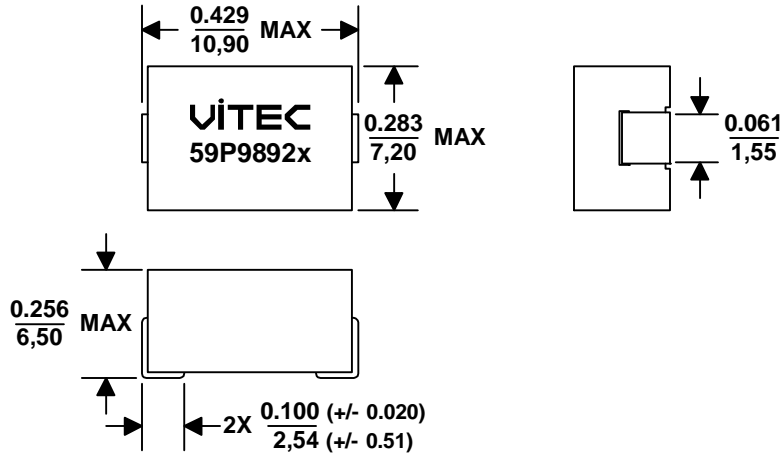


Typical Multi-Phase Application Circuit for a Buck Converter

# SMD High Frequency Power Inductor

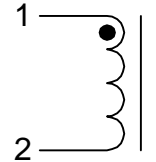
## Designed for VRM 9.x, 10.x, & 11.x Applications

### PACKAGE

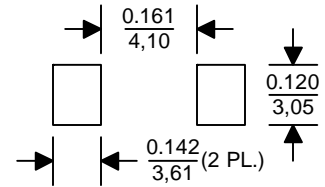


Dimensions: Inches/mm. Tolerances: +/- 0.010"/0,25mm unless otherwise noted

### SCHEMATIC



### SUGGESTED PCB LAYOUT



Drawing NOT to scale

### ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

Part Number		Application Inductance	Inductance @ 0Adc <sup>4</sup>	Inductance @ Irated <sup>4</sup>	Irated <sup>1</sup>	DCR	Saturation Current <sup>2</sup>			Temp. Rise Current <sup>3</sup>	Temp. Rise Factor <sup>5</sup>
Classic	RoHS	nH TYP	nH ± 15%	nH MIN	ADC MAX	mOhm +/- 8%	ADC -40°C	ADC 25°C	ADC 125°C	ADC MAX	
59P9892	59PR9892	200	200	136	42	0.550	43	42	34	33	.0413
59P9892N	59PR9892N	200	200	136	45	0.470	46	45	39	35	.0413

Add an "R" to the part number after "P" for the RoHS compliant version (i.e. 59PR9892 is the RoHS compliant version of 59P9892).

### Notes:

- The rated current is the saturation current @ 25°C.
- The I(Saturation) is the current at which the inductance drops by 20% maximum of its value at 0ADC. This current is measured at the stated ambient environment and by applying a short duration pulse current to the component, minimizing the self-heating effects.
- The I(Temp. Rise) is the current at which the temperature of the part increases by a maximum of 50°C. This test is performed with the part mounted on a PCB with 0.250" wide, 0.004" thick copper traces and applying the DC current for a minimum of 30 minutes.
- Inductance is measured at 100 KHz and 1.0 Vrms.
- The additional Temperature Rise due to High ET (Voltage x Time) can be estimated using the following formula:

$$\text{Trise (}^{\circ}\text{C)} = \left( \frac{\text{Core Loss} + \text{DCR Loss}}{5.47} \right)^{0.833}$$

$$\text{DCR Loss} = \left( \text{Idc}^2 + \left( \frac{\Delta I}{2} \right)^2 \right) \times \text{NOM DCR}$$

$$\text{Core Loss} = 0.00438 \times (F)^{1.84} \times (\text{Temp. Rise Factor} \times \Delta I)^{2.28}$$

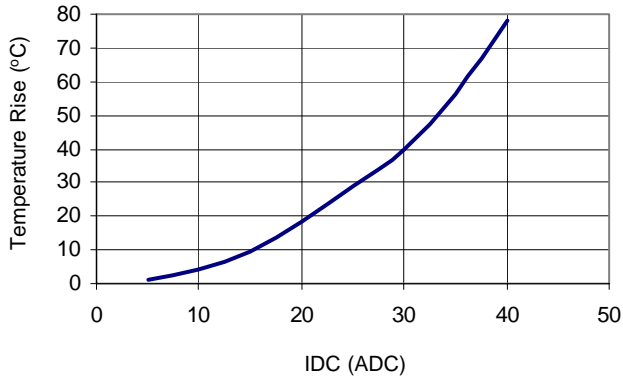
$\Delta I$  = Delta I across the inductor

F = Switching Frequency (kHz)

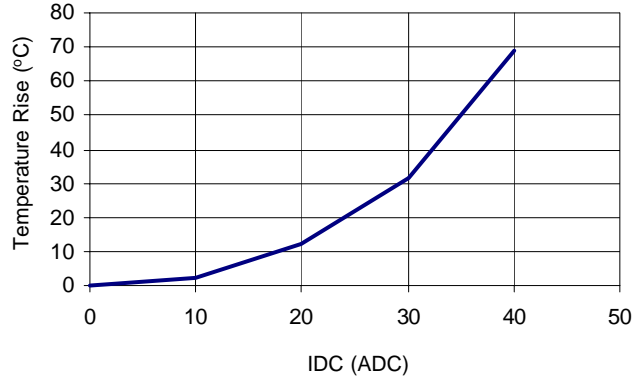
# SMD High Frequency Power Inductor

## Designed for VRM 9.x, 10.x, & 11.x Applications

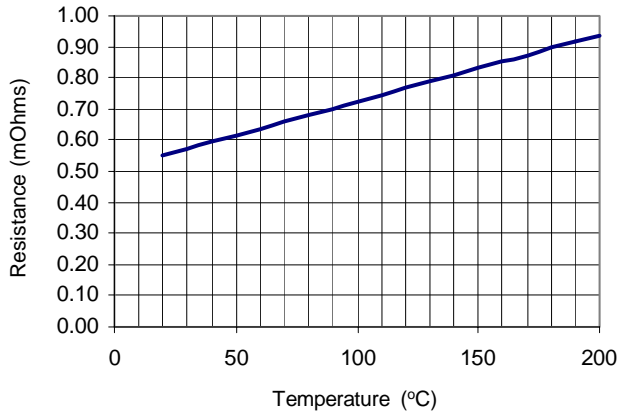
59P9892 Temp. Rise vs. Idc



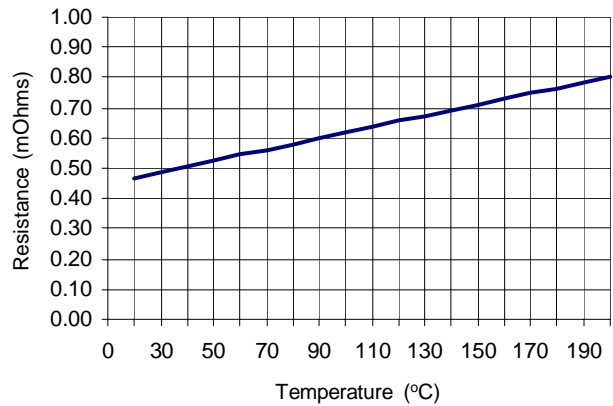
59P9892N Temp. Rise vs. Idc



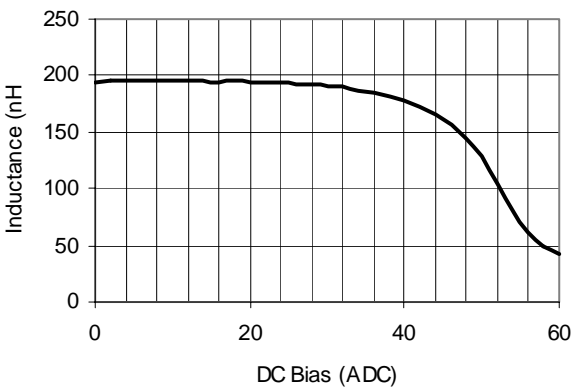
59P9892 Rdc vs. Temp. Rise



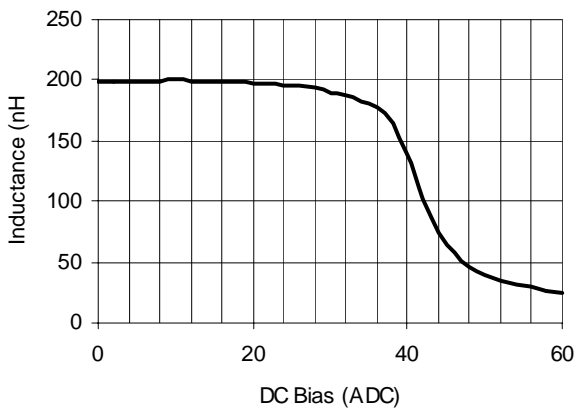
59P9892N Rdc vs. Temp. Rise



59P9892x Inductance vs. Idc @ 25°C



59P9892x Inductance vs. Idc @ 125°C



### ENVIRONMENTAL & RELIABILITY DATA

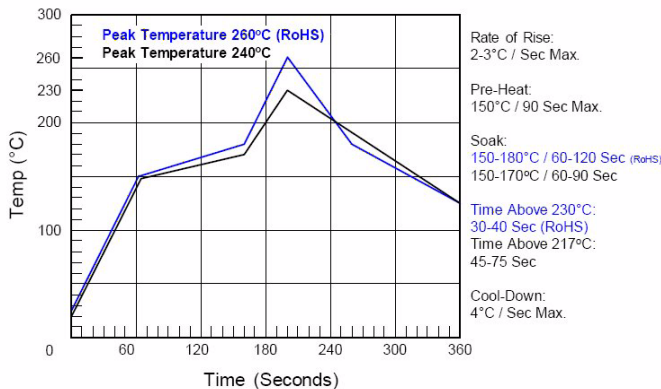
Storage Temperature: -40C to +125C  
 Operating Temperature: -40C to +125C  
 Resistance to Solder Reflow: 3 passes thru. +235C for 30 seconds minimum

Marking permanency: Tested per JESD22-B107-A  
 Solderability: Tested per JESD22-B102D  
 Life Test: Tested per MIL-STD-202F, Method 108A  
 Thermal Cycle: Tested per JESD22-B104-B, Test Condition G

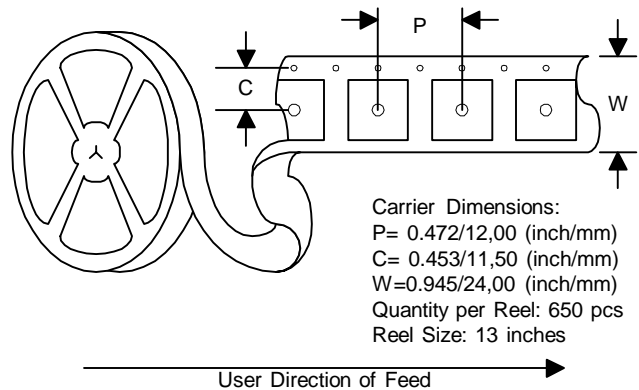
# SMD High Frequency Power Inductor

## Designed for VRM 9.x, 10.x, & 11.x Applications

### IR Profile



### Tape and Reel



### ABOUT US

Vitec Electronics Corporation, founded in 1986, is a worldwide leader in the design, manufacture and sale of magnetic solutions. Vitec's market focus includes the power, power conditioning, telecom, networking, communications and computing. Vitec has also established strong alliances with chip manufacturers whereby magnetic solutions are designed in conjunction with unique silicon requirements and are offered as reference designs by the chip companies.

With its Corporate Headquarters and Research & Development center located in Carlsbad, California, and its state of the art manufacturing facility and material sourcing in China, Vitec is uniquely positioned to supply the latest technology at the lowest cost. Vitec offers both standard and custom product design capabilities with all of its facilities being ISO certified.

### QUALITY POLICY

Vitec will provide products and services that meet or exceed our Customer's requirements, conform to company policies and standards, and exhibit continuously improving levels of Quality.

### COMMITMENT

VITEC Electronics empowers each of its employees by providing a business environment that encourages a commitment to excellence, a sense of ownership and personal accountability to all Vitec Customers.

Competitive Pricing, Quality Products, and On Time Deliveries are expected from today's World Class Magnetics Suppliers. The high standards of today's customer are strengthening the dedication and commitment of VITEC Electronics to provide Total Customer Service.

### CONTACT US

USA

VITEC ELECTRONICS CORPORATION  
6213 El Camino Real  
Carlsbad, CA 92009  
U.S.A.

TEL: +1 (760) 918-8831  
FAX: +1 (760) 918-8840

ASIA

SHANGHAI VITEC ELECTRONICS CO., LTD.  
3369 He Chuan Road  
Min Hang District, Shanghai, 201103  
China

TEL: +86 (21) 6446-4828  
FAX: +86 (21) 6446-4865